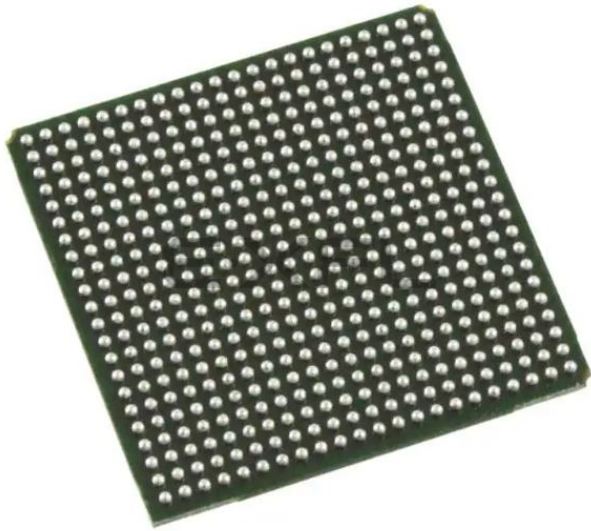




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	4000
Number of Logic Elements/Cells	32000
Total RAM Bits	339968
Number of I/O	331
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-35e-6fn484i

Table 1-2. LatticeECP2M (Including “S-Series”) Family Selection

Device	ECP2M20	ECP2M35	ECP2M50	ECP2M70	ECP2M100
LUTs (K)	19	34	48	67	95
sysMEM Blocks (18kb)	66	114	225	246	288
Embedded Memory (Kbits)	1217	2101	4147	4534	5308
Distributed Memory (Kbits)	41	71	101	145	202
sysDSP Blocks	6	8	22	24	42
18x18 Multipliers	24	32	88	96	168
GPLL+SPLL+DLL	2+6+2	2+6+2	2+6+2	2+6+2	2+6+2
Maximum Available I/O	304	410	410	436	520
Packages and SERDES / I/O Combinations					
256-ball fpBGA (17 x 17 mm)	4 / 140	4 / 140			
484-ball fpBGA (23 x 23 mm)	4 / 304	4 / 303	4 / 270		
672-ball fpBGA (27 x 27 mm)		4 / 410	8 / 372		
900-ball fpBGA (31 x 31 mm)			8 / 410	16 / 416	16 / 416
1152-ball fpBGA (35 x 35 mm)				16 / 436	16 / 520

Introduction

The LatticeECP2/M family of FPGA devices is optimized to deliver high performance features such as advanced DSP blocks, high speed SERDES (LatticeECP2M family only) and high speed source synchronous interfaces in an economical FPGA fabric. This combination was achieved through advances in device architecture and the use of 90nm technology.

The LatticeECP2/M FPGA fabric is optimized with high performance and low cost in mind. The LatticeECP2/M devices include LUT-based logic, distributed and embedded memory, Phase Locked Loops (PLLs), Delay Locked Loops (DLLs), pre-engineered source synchronous I/O support, enhanced sysDSP blocks and advanced configuration support, including encryption (“S” versions only) and dual boot capabilities.

The LatticeECP2M device family features high speed SERDES with PCS. These high jitter tolerance and low transmission jitter SERDES with PCS blocks can be configured to support an array of popular data protocols including PCI Express, Ethernet (1GbE and SGMII), OBSAI and CPRI. Transmit Pre-emphasis and Receive Equalization settings make SERDES suitable for chip to chip and small form factor backplane applications.

Lattice Diamond® design software allows large complex designs to be efficiently implemented using the LatticeECP2/M FPGA family. Synthesis library support for LatticeECP2/M is available for popular logic synthesis tools. The Diamond software uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP2/M device. The Diamond design tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) modules for the LatticeECP2/M family. By using these IP cores as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

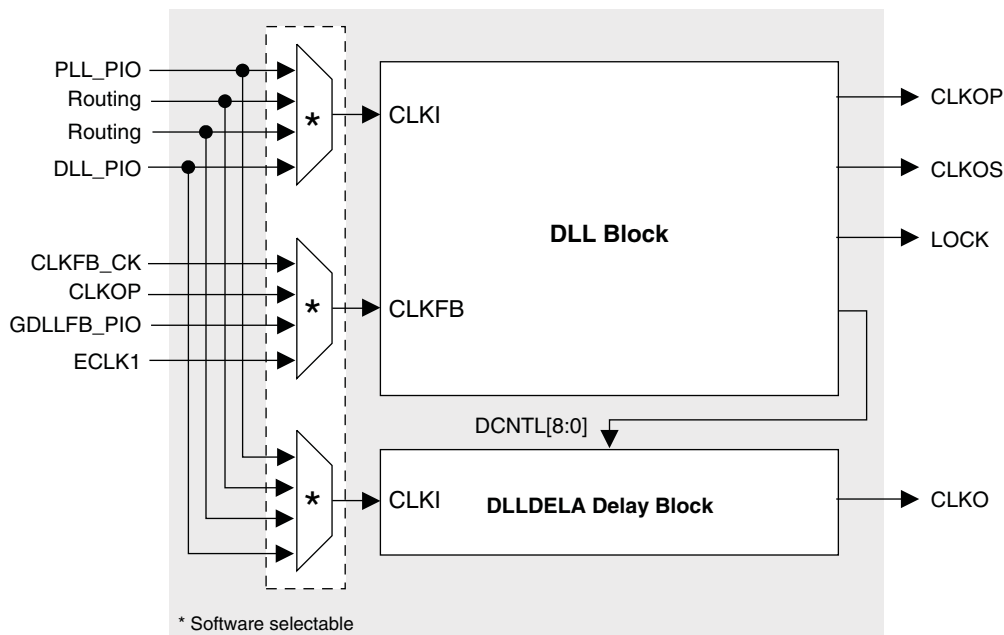
Table 2-5. DLL Signals

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	DLL feed input from DLL output, clock net, routing or external pin
RSTN	I	Active low synchronous reset
ALUHOLD	I	Active high freezes the ALU
UDDCNTL	I	Synchronous enable signal (hold high for two cycles) from routing
DCNTL[8:0]	O	Encoded digital control signals for PIC INDEL and slave delay calibration
CLKOP	O	The primary clock output
CLKOS	O	The secondary clock output with fine phase shift and/or division by 2 or by 4
LOCK	O	Active high phase lock indicator

DLLDELA Delay Block

Closely associated with each DLL is a DLLDELA block. This is a delay block consisting of a delay line with taps and a selection scheme that selects one of the taps. The DCNTL[8:0] bus controls the delay of the CLKO signal. Typically this is the delay setting that the DLL uses to achieve phase alignment. This results in the delay providing a calibrated 90° phase shift that is useful in centering a clock in the middle of a data cycle for source synchronous data. The CLKO signal feeds the edge clock network. Figure 2-7 shows the connections between the DLL block and the DLLDELA delay block. For more information, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-7. DLLDELA Delay Block



PLL/DLL Cascading

LatticeECP2/M devices have been designed to allow certain combinations of PLL (GPLL and SPLL) and DLL cascading. The allowable combinations are:

- PLL to PLL supported
- PLL to DLL supported

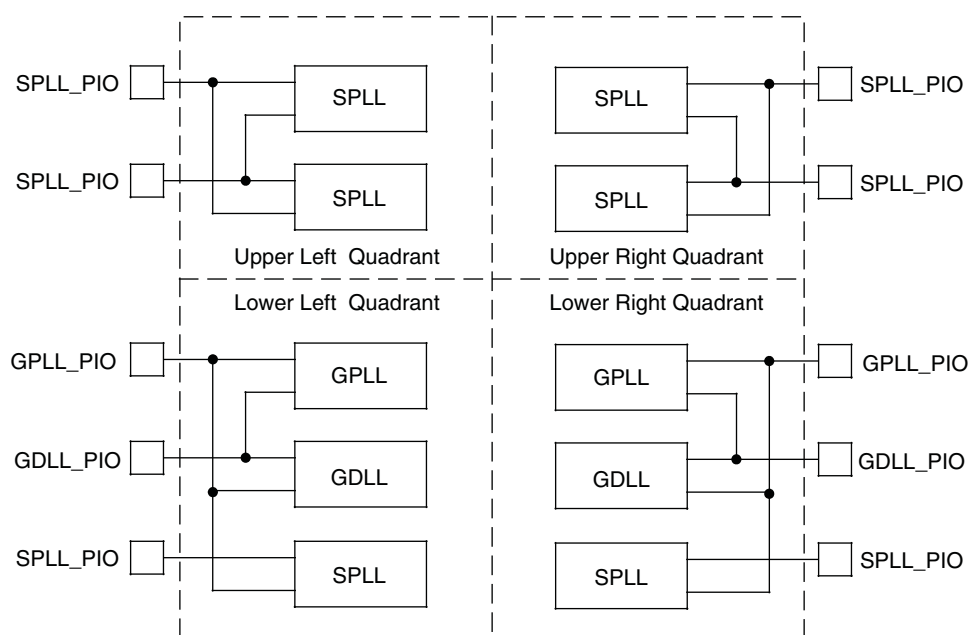
The DLLs in the LatticeECP2/M are used to shift the clock in relation to the data for source synchronous inputs. PLLs are used for frequency synthesis and clock generation for source synchronous interfaces. Cascading PLL and DLL blocks allows applications to utilize the unique benefits of both DLLs and PLLs.

For further information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

GPLL/SPLL/GDLL PIO Input Pin Connections (LatticeECP2M Family Only)

All LatticeECP2M devices contain two GDLLs, two GPLLs and six SPLLs, arranged in quadrants as shown in Figure 2-8. In the LatticeECP2M devices GPLLs, SPLLs and GDLLs share their input pins. Figure 2-8 shows the sharing of SPLLs input pin connections in the upper two quadrants and the sharing of GDLL, GPLL and SPLL input pin connections in the lower two quadrants.

Figure 2-8. Sharing of PIO Pins by GPLL, SPLL and GDLL in LatticeECP2M Devices



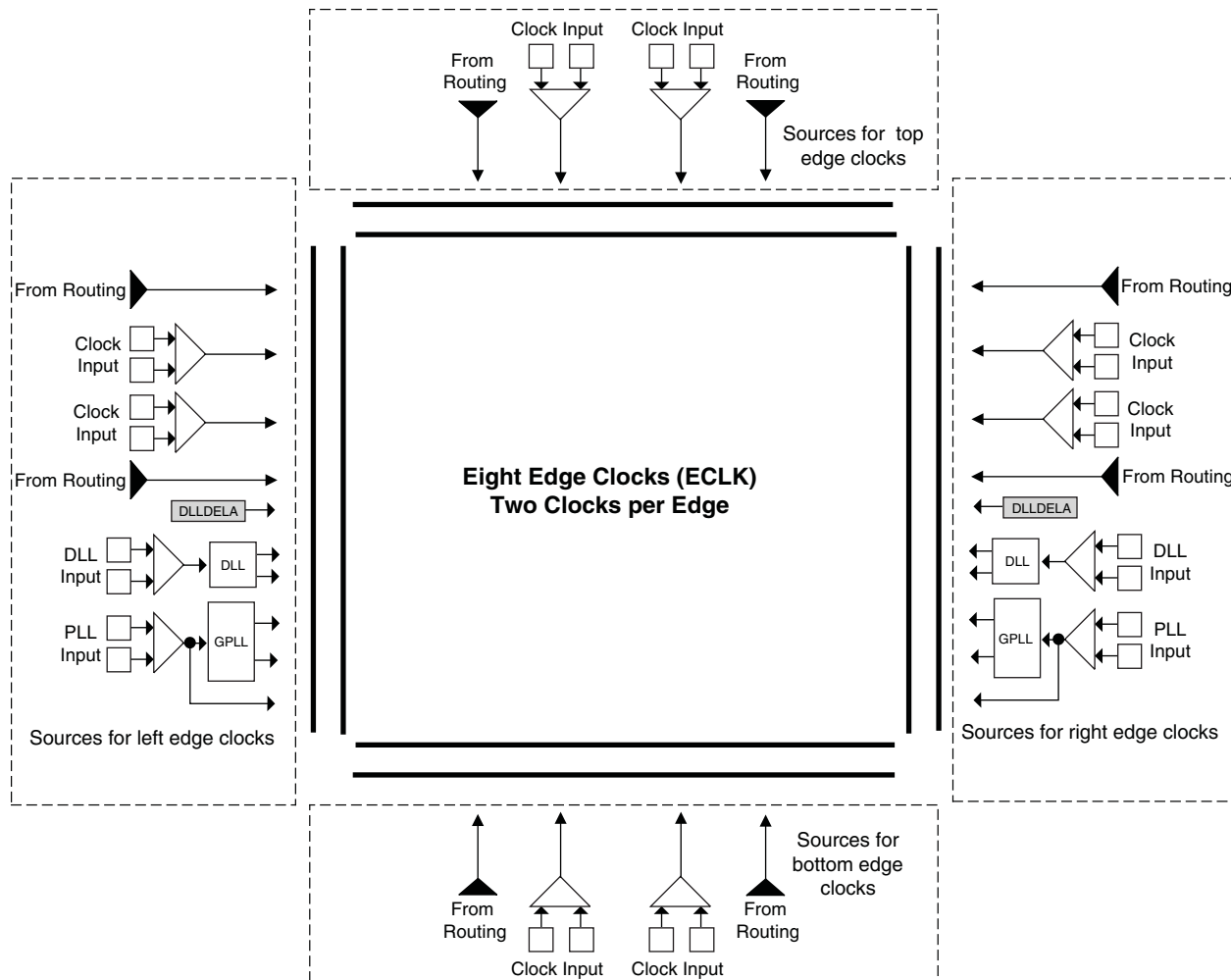
Clock Dividers

LatticeECP2/M devices have two clock dividers, one on the left side and one on the right side of the device. These are intended to generate a slower-speed system clock from a high-speed edge clock. The block operates in a $\div 2$, $\div 4$ or $\div 8$ mode and maintains a known phase relationship between the divided down clock and the high-speed clock based on the release of its reset signal. The clock dividers can be fed from selected PLL/DLL outputs, DLL-DELA delay blocks, routing or from an external clock input. The clock divider outputs serve as primary clock sources and feed into the clock distribution network. The Reset (RST) control signal resets input and synchronously forces all outputs to low. The RELEASE signal releases outputs synchronously to the input clock. For further information about clock dividers, please see the list of additional technical documentation at the end of this data sheet. Figure 2-9 shows the clock divider connections.

Edge Clock Sources

Edge clock resources can be driven from a variety of sources at the same edge. Edge clock resources can be driven from adjacent edge clock PIOs, primary clock PIOs, PLLs/DLLs and clock dividers as shown in Figure 2-12.

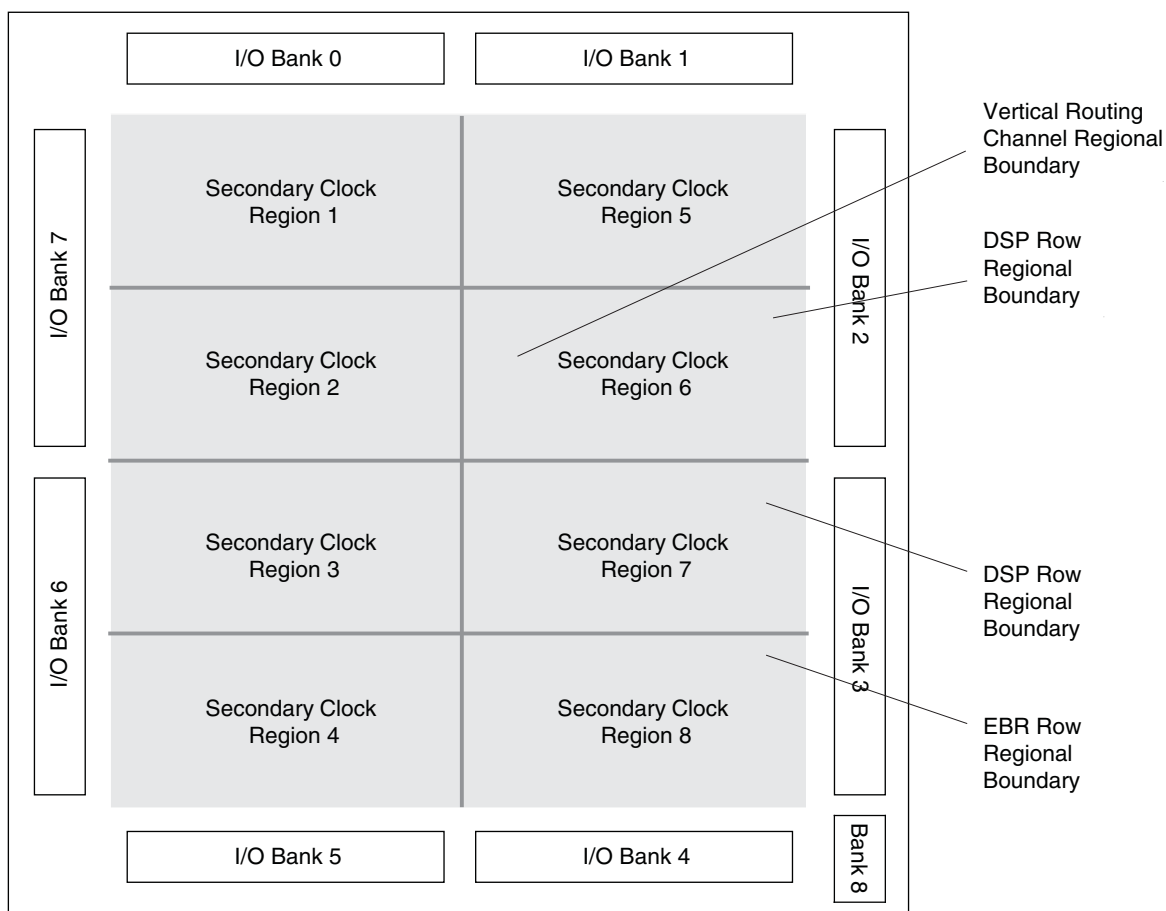
Figure 2-12. Edge Clock Sources



this special vertical routing channel and the eight secondary clock regions for the ECP2-50. LatticeECP2 devices have four secondary clocks (SC0 to SC3) which are distributed to every region.

The secondary clock muxes are located in the center of the device. Figure 2-16 shows the mux structure of the secondary clock routing. Secondary clocks SC0 to SC3 are used for clock and control and SC4 to SC7 are used for high fan-out signals.

Figure 2-15. Secondary Clock Regions ECP2-50



Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]DQS[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQS, num = ball function number.
[LOC]DQ[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQ, associated DQS number.
Test and Programming (Dedicated Pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data Out pin used to shift data out of a device using 1149.1.
VCCJ	—	Power supply pin for JTAG Test Access Port.
Configuration Pads (Used During sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration mode values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI or SPI ₁ m mode.
CSN	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (active low).
D[0]/SPIFASTN	I/O	sysCONFIG Port Data I/O for Parallel mode. sysCONFIG Port Data I/O for SPI or SPI ₁ m. When using the SPI or SPI ₁ m mode, this pin should either be tied high or low, must not be left floating.
D[1:6]	I/O	sysCONFIG Port Data I/O for Parallel
D[7]/SPID0	I/O	sysCONFIG Port Data I/O for Parallel, SPI, SPI ₁ m
DOUT/CSN	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPI0N	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPI ₁ m modes.
Dedicated SERDES Signals^{1, 2, 3}		
[LOC]_SQ_VCCAUX33	—	Termination resistor switching power (3.3V). This pin must be tied to 3.3V even if the quad is unused.
[LOC]_SQ_REFCLKN	I	Negative Reference Clock Input
[LOC]_SQ_REFCLKP	I	Positive Reference Clock Input
[LOC]_SQ_VCCP	—	PLL and Reference clock buffer power (1.2V). This pin must be tied to 1.2V even if the quad is unused.

LatticeECP2 Pin Information Summary, LFE2-50 and LFE2-70

Pin Type		LFE2-50		LFE2-70	
		484 fpBGA	672 fpBGA	672 fpBGA	900 fpBGA
Single Ended User I/O		339	500	500	583
Differential Pair User I/O		169	249	249	290
Configuration	TAP Pins	5	5	5	5
	Muxed Pins	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7
Non Configuration	Muxed Pins	68	79	79	89
	Dedicated Pins	3	3	3	3
VCC		16	20	20	26
VCCAUX		16	16	16	17
VCCPLL		4	4	2	4
VCCIO	Bank0	4	5	5	6
	Bank1	4	5	5	6
	Bank2	4	5	5	6
	Bank3	4	5	5	6
	Bank4	4	5	5	6
	Bank5	4	5	5	6
	Bank6	4	5	5	6
	Bank7	4	5	5	6
	Bank8	2	2	2	2
GND, GND0 to GND7		60	72	72	104
NC		0	3	5	101
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	50/25	67/33	67/33	84/42
	Bank1	46/23	66/33	66/33	76/38
	Bank2	38/19	56/28	56/28	74/37
	Bank3	22/11	48/24	48/24	48/24
	Bank4	46/23	62/31	62/31	72/35
	Bank5	46/23	68/34	68/34	80/40
	Bank6	40/20	64/32	64/32	64/32
	Bank7	37/18	55/27	55/27	71/35
	Bank8	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0
	Bank2 (Right Edge)	9	13	13	18
	Bank3 (Right Edge)	5	12	12	12
	Bank4 (Bottom Edge)	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0
	Bank6 (Left Edge)	10	16	16	16
	Bank7 (Left Edge)	8	12	12	16
	Bank8 (Right Edge)	0	0	0	0

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
184	GND	-			GND	-			
185	PT28A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
186	PT26B	0		C	PT36B	0		C	
187	PT26A	0		T	PT36A	0		T	
188	VCC	-			VCC	-			
189	PT20B	0		C	PT30B	0		C	
190	VCCAUX	-			VCCAUX	-			
191	PT20A	0		T	PT30A	0		T	
192	GND	-			GND	-			
193	PT18B	0		C	PT26B	0		C	
194	PT18A	0		T	PT26A	0		T	
195	VCCIO0	0			VCCIO0	0			
196	PT16B	0		C	PT20B	0		C	
197	PT16A	0		T	PT20A	0		T	
198	VCC	-			VCC	-			
199	PT12B	0		C	PT12B	0		C	
200	PT12A	0		T	PT12A	0		T	
201	GND	-			GND	-			
202	PT8B	0		C	PT8B	0		C	
203	PT8A	0		T	PT8A	0		T	
204	PT6B	0		C	PT6B	0		C	
205	PT6A	0		T	PT6A	0		T	
206	VCCIO0	0			VCCIO0	0			
207	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
208	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M8	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
GND	GNDIO5	-			GNDIO5	-		
P7	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
R8	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
VCCIO	VCCIO4	4			VCCIO4	4		
T5	PB14A	4	BDQ15	T	PB32A	4	BDQ33	T
T6	PB14B	4	BDQ15	C	PB32B	4	BDQ33	C
T8	PB15A	4	BDQS15	T	PB33A	4	BDQS33	T
GND	GNDIO4	-			GNDIO4	-		
R7	PB16A	4	BDQ15	T	PB34A	4	BDQ33	T
T9	PB15B	4	BDQ15	C	PB33B	4	BDQ33	C
T7	PB16B	4	BDQ15	C	PB34B	4	BDQ33	C
L8	PB17A	4	BDQ15	T	PB35A	4	BDQ33	T
VCCIO	VCCIO4	4			VCCIO4	4		
P8	PB18A	4	BDQ15	T	PB36A	4	BDQ33	T
L9	PB17B	4	BDQ15	C	PB35B	4	BDQ33	C
N8	PB18B	4	BDQ15	C	PB36B	4	BDQ33	C
R9	PB19A	4	BDQ15	T	PB37A	4	BDQ33	T
GND	GNDIO4	-			GNDIO4	-		
R10	PB19B	4	BDQ15	C	PB37B	4	BDQ33	C
-	-	-			VCCIO	4		
-	-	-			GNDIO4	4		
N9	PB20A	4	BDQ24	T	PB47A	4	BDQ51	T
T10	PB21A	4	BDQ24	T	PB48A	4	BDQ51	T
M9	PB20B	4	BDQ24	C	PB47B	4	BDQ51	C
R11	PB21B	4	BDQ24	C	PB48B	4	BDQ51	C
P10	PB22A	4	BDQ24	T	PB49A	4	BDQ51	T
N11	PB23A	4	BDQ24	T	PB50A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
N10	PB22B	4	BDQ24	C	PB49B	4	BDQ51	C
P11	PB23B	4	BDQ24	C	PB50B	4	BDQ51	C
T11	PB24A	4	BDQS24	T	PB51A	4	BDQS51	T
GND	GNDIO4	-			GNDIO4	-		
M11	PB25A	4	BDQ24	T	PB52A	4	BDQ51	T
T12	PB24B	4	BDQ24	C	PB51B	4	BDQ51	C
L11	PB25B	4	BDQ24	C	PB52B	4	BDQ51	C
T13	PB26A	4	BDQ24	T	PB53A	4	BDQ51	T
R13	PB27A	4	BDQ24	T	PB54A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
T14	PB26B	4	BDQ24	C	PB53B	4	BDQ51	C
P13	PB27B	4	BDQ24	C	PB54B	4	BDQ51	C
GND	GNDIO4	-			GNDIO4	-		
N12	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
M12	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
R15	CFG2	8			CFG2	8		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T7	PL29B	6	LDQ28	C	PL43B	6	LDQ42	C	
T6	PL26B	6	LDQ28	C (LVDS)*	PL40B	6	LDQ42	C (LVDS)*	
AA2	PL31A	6	LDQ28	T	PL45A	6	LDQ42	T	
VCCIO	VCCIO6	6			VCCIO6	6			
Y1	PL28A	6	LDQS28	T (LVDS)*	PL42A	6	LDQS42	T (LVDS)*	
AA1	PL31B	6	LDQ28	C	PL45B	6	LDQ42	C	
W1	PL28B	6	LDQ28	C (LVDS)*	PL42B	6	LDQ42	C (LVDS)*	
V3	PL30B	6	LDQ28	C (LVDS)*	PL44B	6	LDQ42	C (LVDS)*	
GNDIO	GNDIO6	-			GNDIO	-			
V4	PL30A	6	LDQ28	T (LVDS)*	PL44A	6	LDQ42	T (LVDS)*	
U5	TDI	-			TDI	-			
U7	TCK	-			TCK	-			
V6	TDO	-			TDO	-			
V5	TMS	-			TMS	-			
T8	VCCJ	-			VCCJ	-			
W4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
Y3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
W3	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
Y2	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
AB3	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
W5	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
AB2	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
W6	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
AB5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
GNDIO	GNDIO5	-			GNDIO	-			
Y4	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
AB4	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
AA3	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
AB6	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AA5	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
AA6	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
GNDIO	GNDIO5	-			GNDIO	-			
-	-	-			VCCIO5	5			
Y6	PB12A	5	BDQ15	T	PB21A	5	BDQ24	T	
W7	PB11A	5	BDQ15	T	PB20A	5	BDQ24	T	
Y7	PB12B	5	BDQ15	C	PB21B	5	BDQ24	C	
W8	PB11B	5	BDQ15	C	PB20B	5	BDQ24	C	
U8	PB14A	5	BDQ15	T	PB23A	5	BDQ24	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AA7	PB13A	5	BDQ15	T	PB22A	5	BDQ24	T	
U9	PB14B	5	BDQ15	C	PB23B	5	BDQ24	C	

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
J22	PR29B	3	RDQ31	C (LVDS)*	PR48B	3	RDQ50	C (LVDS)*
H22	PR29A	3	RDQ31	T (LVDS)*	PR48A	3	RDQ50	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO	3		
M20	PR28B	3	VREF2_3/RDQ31	C	PR47B	3	VREF2_3/RDQ50	C
L21	PR28A	3	VREF1_3/RDQ31	T	PR47A	3	VREF1_3/RDQ50	T
K21	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*	PR46B	3	PCLKC3_0/RDQ50	C (LVDS)*
J21	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*	PR46A	3	PCLKT3_0/RDQ50	T (LVDS)*
M18	PR25B	2	PCLKC2_0/RDQ22	C	PR44B	2	PCLKC2_0/RDQ41	C
L17	PR25A	2	PCLKT2_0/RDQ22	T	PR44A	2	PCLKT2_0/RDQ41	T
GNDIO	GNDIO2	-			GNDIO2	-		
L19	PR24B	2	RDQ22	C (LVDS)*	PR43B	2	RDQ41	C (LVDS)*
L20	PR24A	2	RDQ22	T (LVDS)*	PR43A	2	RDQ41	T (LVDS)*
L18	PR23B	2	RDQ22	C	PR42B	2	RDQ41	C
K17	PR23A	2	RDQ22	T	PR42A	2	RDQ41	T
VCCIO	VCCIO2	2			VCCIO	2		
K18	PR22B	2	RDQ22	C (LVDS)*	PR41B	2	RDQ41	C (LVDS)*
K19	PR22A	2	RDQS22	T (LVDS)*	PR41A	2	RDQS41	T (LVDS)*
G22	PR21B	2	RDQ22	C	PR40B	2	RDQ41	C
GNDIO	GNDIO2	-			GNDIO2	-		
F22	PR21A	2	RDQ22	T	PR40A	2	RDQ41	T
J17	PR20B	2	RDQ22	C (LVDS)*	PR39B	2	RDQ41	C (LVDS)*
J18	PR20A	2	RDQ22	T (LVDS)*	PR39A	2	RDQ41	T (LVDS)*
K20	PR19B	2	RDQ22	C	PR38B	2	RDQ41	C
VCCIO	VCCIO2	2			VCCIO	2		
J19	PR19A	2	RDQ22	T	PR38A	2	RDQ41	T
H21	PR18B	2	RDQ22	C (LVDS)*	PR37B	2	RDQ41	C (LVDS)*
G21	PR18A	2	RDQ22	T (LVDS)*	PR37A	2	RDQ41	T (LVDS)*
-	-	-			GNDIO2	-		
-	-	-			VCCIO	2		
H17	NC	-			PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C
H16	NC	-			PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T
H20	NC	-			PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C
H18	NC	-			PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T
-	-	-			GNDIO2	-		
-	-	-			VCCIO	2		
F21	PR17B	2	RDQ14	C	PR19B	2	RDQ16	C
GNDIO	GNDIO2	-			GNDIO2	-		
E22	PR17A	2	RDQ14	T	PR19A	2	RDQ16	T
D22	PR16B	2	RDQ14	C (LVDS)*	PR18B	2	RDQ16	C (LVDS)*
E21	PR16A	2	RDQ14	T (LVDS)*	PR18A	2	RDQ16	T (LVDS)*
G20	PR15B	2	RDQ14	C	PR17B	2	RDQ16	C
VCCIO	VCCIO2	2			VCCIO	2		
F20	PR15A	2	RDQ14	T	PR17A	2	RDQ16	T
H19	PR14B	2	RDQ14	C (LVDS)*	PR16B	2	RDQ16	C (LVDS)*
G19	PR14A	2	RDQS14	T (LVDS)*	PR16A	2	RDQS16	T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
K1	PL27B	7	LDQ29	C (LVDS)*
K5	PL28A	7	LDQ29	T
K7	PL28B	7	LDQ29	C
GND	GNDIO7	-		
K4	PL29A	7	LDQS29	T (LVDS)*
K3	PL29B	7	LDQ29	C (LVDS)*
L8	PL30A	7	LDQ29	T
VCCIO	VCCIO7	7		
L6	PL30B	7	LDQ29	C
L2	PL31A	7	LDQ29	T (LVDS)*
L1	PL31B	7	LDQ29	C (LVDS)*
L7	PL32A	7	LDQ29	T
GND	GNDIO7	-		
L5	PL32B	7	LDQ29	C
L4	PL33A	7	LDQ37	T (LVDS)*
L3	PL33B	7	LDQ37	C (LVDS)*
M8	PL34A	7	LDQ37	T
M6	PL34B	7	LDQ37	C
VCCIO	VCCIO7	7		
M2	PL35A	7	LDQ37	T (LVDS)*
M1	PL35B	7	LDQ37	C (LVDS)*
M7	PL36A	7	LDQ37	T
M5	PL36B	7	LDQ37	C
GND	GNDIO7	-		
M4	PL37A	7	LDQS37	T (LVDS)*
M3	PL37B	7	LDQ37	C (LVDS)*
N6	PL38A	7	LUM0_SPLLT_IN_A/LDQ37	T
VCCIO	VCCIO7	7		
N8	PL38B	7	LUM0_SPLLC_IN_A/LDQ37	C
N5	PL39A	7	LUM0_SPLLT_FB_A/LDQ37	T
N7	PL39B	7	LUM0_SPLLC_FB_A/LDQ37	C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
T9	PL50A	7	LDQ54	
R9	PL51A	7	LDQ54	T
P7	PL51B	7	LDQ54	C
VCCIO	VCCIO7	7		
N2	PL52A	7	LDQ54	T (LVDS)*
N1	PL52B	7	LDQ54	C (LVDS)*
P6	PL53A	7	LDQ54	T
P5	PL53B	7	LDQ54	C
GND	GNDIO7	-		
P4	PL54A	7	LDQS54	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AD18	PB66A	4	BDQ69	T
AF18	PB66B	4	BDQ69	C
AC18	PB67A	4	BDQ69	T
AE18	PB67B	4	BDQ69	C
VCCIO	VCCIO4	4		
AG19	PB68A	4	BDQ69	T
AH19	PB68B	4	BDQ69	C
GND	GNDIO4	-		
AE19	PB69A	4	BDQS69	T
AF19	PB69B	4	BDQ69	C
AC19	PB70A	4	BDQ69	T
AD19	PB70B	4	BDQ69	C
AJ19	PB71A	4	BDQ69	T
AK19	PB71B	4	BDQ69	C
VCCIO	VCCIO4	4		
AF20	PB72A	4	BDQ69	T
AH20	PB72B	4	BDQ69	C
AE20	PB73A	4	BDQ69	T
AG20	PB73B	4	BDQ69	C
GND	GNDIO4	-		
AD20	PB74A	4	BDQ78	T
AC20	PB74B	4	BDQ78	C
AH21	PB75A	4	BDQ78	T
AF21	PB75B	4	BDQ78	C
AJ20	PB76A	4	BDQ78	T
VCCIO	VCCIO4	4		
AK20	PB76B	4	BDQ78	C
AG21	PB77A	4	BDQ78	T
AE21	PB77B	4	BDQ78	C
AD21	PB78A	4	BDQS78	T
GND	GNDIO4	-		
AC21	PB78B	4	BDQ78	C
AD22	PB79A	4	BDQ78	T
AB21	PB79B	4	BDQ78	C
AJ21	PB80A	4	BDQ78	T
VCCIO	VCCIO4	4		
AK21	PB80B	4	BDQ78	C
GND	GNDIO4	-		
VCCIO	VCCIO4	4		
AJ25	PB87A	4	BDQS87***	T
AK24	PB87B	4	BDQ87	C
AJ24	PB88A	4	BDQ87	T
AK25	PB88B	4	BDQ87	C

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
L11	GND	-		
L12	GND	-		
L13	GND	-		
M10	GND	-		
M11	GND	-		
M12	GND	-		
M13	GND	-		
N10	GND	-		
N11	GND	-		
N12	GND	-		
N13	GND	-		
N15	GND	-		
N20	GND	-		
N3	GND	-		
N8	GND	-		
P14	GND	-		
P9	GND	-		
R10	GND	-		
R13	GND	-		
T19	GND	-		
T4	GND	-		
W16	GND	-		
W2	GND	-		
W21	GND	-		
W7	GND	-		
Y10	GND	-		
Y13	GND	-		
Y15	NC	-		
W15	NC	-		
AB20	NC	-		
AB21	NC	-		
AA21	NC	-		
AA20	NC	-		
AB19	NC	-		
AB18	NC	-		
Y22	NC	-		
Y21	NC	-		
Y17	NC	-		
Y18	NC	-		
Y16	NC	-		
W17	NC	-		
Y19	NC	-		
Y20	NC	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AJ30	LRC_SQ_VCCIB0	13		
AK29	LRC_SQ_HDINP0	13		T
AH30	LRC_SQ_VCCRX0	13		
AG27	CFG2	8		
AD25	CFG1	8		
AG28	CFG0	8		
AG30	PROGRAMN	8		
AG29	CCLK	8		
AC24	INITN	8		
AF27	DONE	8		
GNDIO	GNDIO8	-		
AF28	WRITEN***	8		
AE26	CS1N***	8		
AB23	CSN***	8		
AF29	D0/SPIFASTN***	8		
VCCIO	VCCIO8	8		
AF30	D1***	8		
AD26	D2***	8		
AE29	D3***	8		
GNDIO	GNDIO8	-		
AE30	D4***	8		
AD29	D5***	8		
AC25	D6***	8		
AD30	D7/SPID0***	8		
VCCIO	VCCIO8	8		
AA22	DI/CSSPI0N***	8		
AC26	DOUT/CSON/CSSPI1N***	8		
AA23	BUSY/SISPI***	8		
AB22	RLM0_PLLCAP	3		
AC27	PR102B	3	RLM0_GDLLC_FB_A/RDQ99	C
GNDIO	GNDIO3	-		
AC28	PR102A	3	RLM0_GDLLT_FB_A/RDQ99	T
AC29	PR101B	3	RLM0_GDLLC_IN_A**/RDQ99	C (LVDS)*
AC30	PR101A	3	RLM0_GDLLT_IN_A**/RDQ99	T (LVDS)*
AB30	PR100B	3	RLM0_GPLLC_IN_A**/RDQ99	C
VCCIO	VCCIO3	3		
AA30	PR100A	3	RLM0_GPLLT_IN_A**/RDQ99	T
AB29	PR99B	3	RLM0_GPLLC_FB_A/RDQ99	C (LVDS)*
AB28	PR99A	3	RLM0_GPLLT_FB_A/RDQS99	T (LVDS)*
GNDIO	GNDIO3	-		
Y22	PR98B	3	RDQ99	C
Y23	PR98A	3	RDQ99	T
AB26	PR97B	3	RDQ99	C (LVDS)*

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M19	VCC	-		
M20	VCC	-		
N11	VCC	-		
N12	VCC	-		
N19	VCC	-		
N20	VCC	-		
P12	VCC	-		
P19	VCC	-		
R12	VCC	-		
R19	VCC	-		
T12	VCC	-		
T19	VCC	-		
U12	VCC	-		
U19	VCC	-		
V11	VCC	-		
V12	VCC	-		
V19	VCC	-		
V20	VCC	-		
W11	VCC	-		
W12	VCC	-		
W13	VCC	-		
W14	VCC	-		
W15	VCC	-		
W16	VCC	-		
W17	VCC	-		
W18	VCC	-		
W19	VCC	-		
W20	VCC	-		
Y12	VCC	-		
Y13	VCC	-		
Y18	VCC	-		
Y19	VCC	-		
D14	VCCIO0	0		
E6	VCCIO0	0		
E9	VCCIO0	0		
F12	VCCIO0	0		
K12	VCCIO0	0		
K13	VCCIO0	0		
D17	VCCIO1	1		
E22	VCCIO1	1		
E25	VCCIO1	1		
F19	VCCIO1	1		
K18	VCCIO1	1		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AE27	GND	-		
AE4	GND	-		
AE9	GND	-		
AF14	GND	-		
AF17	GND	-		
AF25	GND	-		
AF6	GND	-		
AJ10	GND	-		
AJ21	GND	-		
AJ27	GND	-		
AJ4	GND	-		
AK1	GND	-		
AK13	GND	-		
AK18	GND	-		
AK24	GND	-		
AK30	GND	-		
AK7	GND	-		
B10	GND	-		
B21	GND	-		
B27	GND	-		
B4	GND	-		
D25	GND	-		
D6	GND	-		
E14	GND	-		
E17	GND	-		
F22	GND	-		
F27	GND	-		
F4	GND	-		
F9	GND	-		
G12	GND	-		
G19	GND	-		
J24	GND	-		
J7	GND	-		
K14	GND	-		
K15	GND	-		
K16	GND	-		
K17	GND	-		
K27	GND	-		
K4	GND	-		
L14	GND	-		
L15	GND	-		
L16	GND	-		
L17	GND	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
V18	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** These sysCONFIG pins are dedicated I/O pins for configuration. The outputs are actively driven during normal device operation.

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
W30	PR53A	3	RDQ55	T (LVDS)*	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
U27	PR52B	3	VREF2_3/RDQ55	C	PR60B	3	VREF2_3/RDQ63	C
V29	PR52A	3	VREF1_3/RDQ55	T	PR60A	3	VREF1_3/RDQ63	T
V31	PR51B	3	PCLKC3_0/RDQ55	C (LVDS)*	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
V32	PR51A	3	PCLKT3_0/RDQ55	T (LVDS)*	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
V33	PR49B	2	PCLKC2_0/RDQ46	C	PR57B	2	PCLKC2_0/RDQ54	C
V34	PR49A	2	PCLKT2_0/RDQ46	T	PR57A	2	PCLKT2_0/RDQ54	T
GNDIO	GNDIO2	-			GNDIO2	-		
U24	PR48B	2	RDQ46	C (LVDS)*	PR56B	2	RDQ54	C (LVDS)*
U25	PR48A	2	RDQ46	T (LVDS)*	PR56A	2	RDQ54	T (LVDS)*
V30	PR47B	2	RDQ46	C	PR55B	2	RDQ54	C
Y32	PR47A	2	RDQ46	T	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2			VCCIO2	2		
U28	PR46B	2	RDQ46	C (LVDS)*	PR54B	2	RDQ54	C (LVDS)*
U29	PR46A	2	RDQS46	T (LVDS)*	PR54A	2	RDQS54	T (LVDS)*
U33	PR45B	2	RDQ46	C	PR53B	2	RDQ54	C
GNDIO	GNDIO2	-			GNDIO2	-		
U34	PR45A	2	RDQ46	T	PR53A	2	RDQ54	T
T30	PR44B	2	RDQ46	C (LVDS)*	PR52B	2	RDQ54	C (LVDS)*
U30	PR44A	2	RDQ46	T (LVDS)*	PR52A	2	RDQ54	T (LVDS)*
T29	PR43B	2	RUM3_SPLLC_FB_A/RDQ46	C	PR51B	2	RUM3_SPLLC_FB_A/RDQ54	C
VCCIO	VCCIO2	2			VCCIO2	2		
T28	PR43A	2	RUM3_SPLLT_FB_A/RDQ46	T	PR51A	2	RUM3_SPLLT_FB_A/RDQ54	T
U31	PR42B	2	RUM3_SPLLC_IN_A/RDQ46	C (LVDS)*	PR50B	2	RUM3_SPLLC_IN_A/RDQ54	C (LVDS)*
U32	PR42A	2	RUM3_SPLLT_IN_A/RDQ46	T (LVDS)*	PR50A	2	RUM3_SPLLT_IN_A/RDQ54	T (LVDS)*
T33	PR40B	2	RDQ37	C	PR48B	2	RDQ45	C
T34	PR40A	2	RDQ37	T	PR48A	2	RDQ45	T
GNDIO	GNDIO2	-			GNDIO2	-		
R27	PR39B	2	RDQ37	C (LVDS)*	PR47B	2	RDQ45	C (LVDS)*
R28	PR39A	2	RDQ37	T (LVDS)*	PR47A	2	RDQ45	T (LVDS)*
R29	PR38B	2	RDQ37	C	PR46B	2	RDQ45	C
R30	PR38A	2	RDQ37	T	PR46A	2	RDQ45	T
VCCIO	VCCIO2	2			VCCIO2	2		
R33	PR37B	2	RDQ37	C (LVDS)*	PR45B	2	RDQ45	C (LVDS)*
R34	PR37A	2	RDQS37	T (LVDS)*	PR45A	2	RDQS45	T (LVDS)*
R32	PR36B	2	RDQ37	C	PR44B	2	RDQ45	C
GNDIO	GNDIO2	-			GNDIO2	-		
R31	PR36A	2	RDQ37	T	PR44A	2	RDQ45	T
P34	PR35B	2	RDQ37	C (LVDS)*	PR43B	2	RDQ45	C (LVDS)*
P33	PR35A	2	RDQ37	T (LVDS)*	PR43A	2	RDQ45	T (LVDS)*
R26	PR34B	2	RDQ37	C	PR42B	2	RDQ45	C
VCCIO	VCCIO2	2			VCCIO2	2		
T25	PR34A	2	RDQ37	T	PR42A	2	RDQ45	T
P28	PR33B	2	RDQ37	C (LVDS)*	PR41B	2	RDQ45	C (LVDS)*
P27	PR33A	2	RDQ37	T (LVDS)*	PR41A	2	RDQ45	T (LVDS)*
P30	NC	-			PR40B	2		C
-	-	-			GNDIO2	-		
P29	NC	-			PR40A	2		T

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	Ind	20
LFE2-20SE-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	Ind	20
LFE2-20SE-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	Ind	20
LFE2-20SE-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	Ind	20
LFE2-20SE-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	Ind	20
LFE2-20SE-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	Ind	20
LFE2-20SE-5FN672I	402	1.2V	-5	Lead-Free fpBGA	672	Ind	20
LFE2-20SE-6FN672I	402	1.2V	-6	Lead-Free fpBGA	672	Ind	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	Ind	35
LFE2-35SE-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	Ind	35
LFE2-35SE-5FN672I	450	1.2V	-5	Lead-Free fpBGA	672	Ind	35
LFE2-35SE-6FN672I	450	1.2V	-6	Lead-Free fpBGA	672	Ind	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5FN484I	339	1.2V	-5	Lead-Free fpBGA	484	Ind	50
LFE2-50SE-6FN484I	339	1.2V	-6	Lead-Free fpBGA	484	Ind	50
LFE2-50SE-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	Ind	50
LFE2-50SE-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	Ind	70
LFE2-70SE-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	Ind	70
LFE2-70SE-5FN900I	583	1.2V	-5	Lead-Free fpBGA	900	Ind	70
LFE2-70SE-6FN900I	583	1.2V	-6	Lead-Free fpBGA	900	Ind	70